

SGH23N60UFD

Ultra-Fast IGBT

General Description

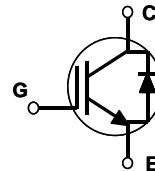
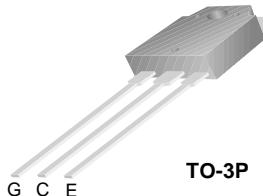
Fairchild's Insulated Gate Bipolar Transistor(IGBT) UFD series provides low conduction and switching losses. UFD series is designed for the applications such as motor control and general inverters where High Speed Switching is required.

Features

- High Speed Switching
- Low Saturation Voltage : $V_{CE(sat)} = 2.1 \text{ V}$ @ $I_C = 12\text{A}$
- High Input Impedance
- CO-PAK, IGBT with FRD : $t_{rr} = 42\text{ns}$ (typ.)

Application

AC & DC Motor controls, General Purpose Inverters, Robotics, Servo Controls



Absolute Maximum Ratings

$T_C = 25^\circ\text{C}$ unless otherwise noted

Symbol	Description	SGH23N60UFD	Units
V_{CES}	Collector-Emitter Voltage	600	V
V_{GES}	Gate-Emitter Voltage	± 20	V
I_C	Collector Current @ $T_C = 25^\circ\text{C}$	23	A
	Collector Current @ $T_C = 100^\circ\text{C}$	12	A
$I_{CM(1)}$	Pulsed Collector Current	92	A
I_F	Diode Continuous Forward Current @ $T_C = 100^\circ\text{C}$	12	A
I_{FM}	Diode Maximum Forward Current	92	A
P_D	Maximum Power Dissipation @ $T_C = 25^\circ\text{C}$	100	W
	Maximum Power Dissipation @ $T_C = 100^\circ\text{C}$	40	W
T_J	Operating Junction Temperature	-55 to +150	$^\circ\text{C}$
T_{stg}	Storage Temperature Range	-55 to +150	$^\circ\text{C}$
T_L	Maximum Lead Temp. for Soldering Purposes, 1/8" from Case for 5 Seconds	300	$^\circ\text{C}$

Notes :

(1) Repetitive rating : Pulse width limited by max. junction temperature

Thermal Characteristics

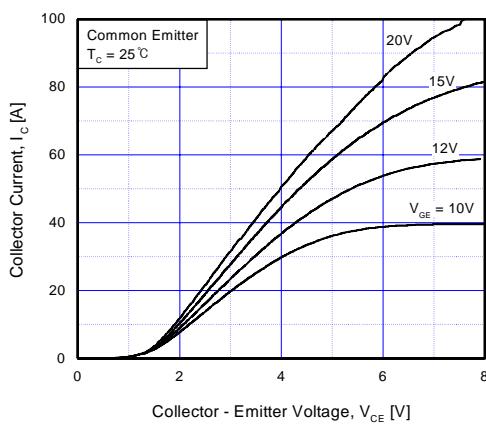
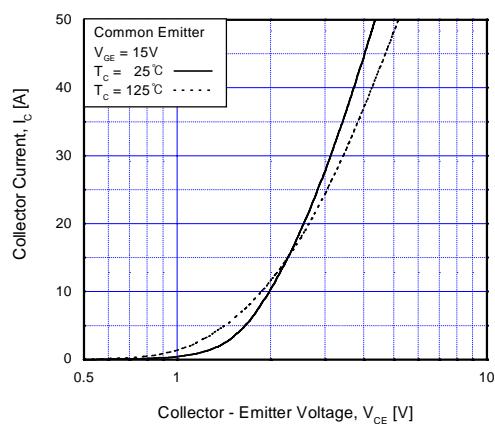
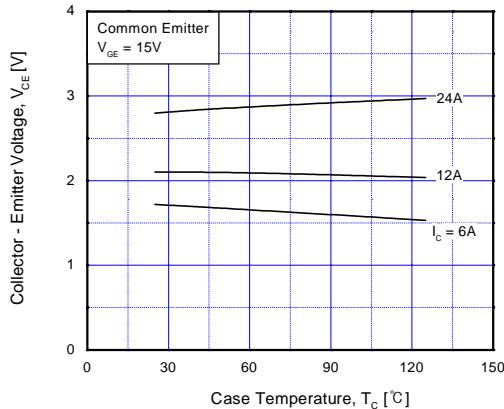
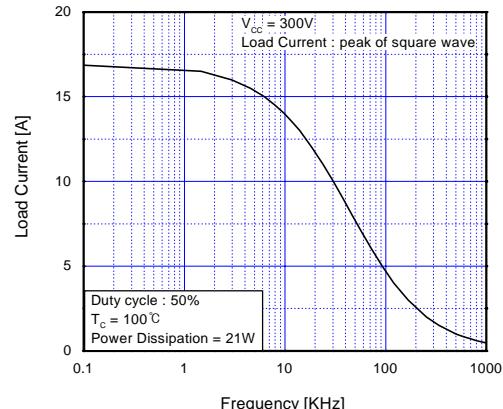
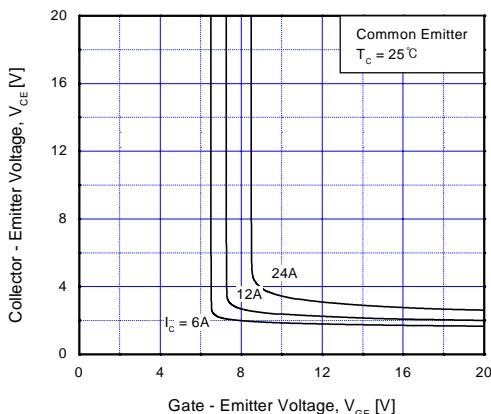
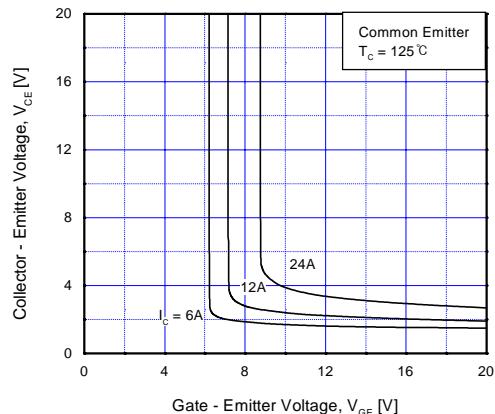
Symbol	Parameter	Typ.	Max.	Units
$R_{\theta JC}(\text{IGBT})$	Thermal Resistance, Junction-to-Case	--	1.2	$^\circ\text{C/W}$
$R_{\theta JC}(\text{DIODE})$	Thermal Resistance, Junction-to-Case	--	2.5	$^\circ\text{C/W}$
$R_{\theta JA}$	Thermal Resistance, Junction-to-Ambient	--	40	$^\circ\text{C/W}$

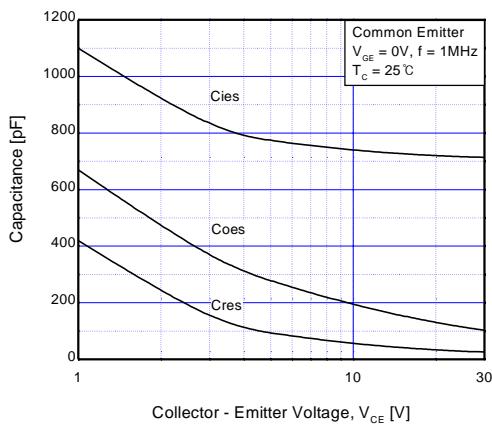
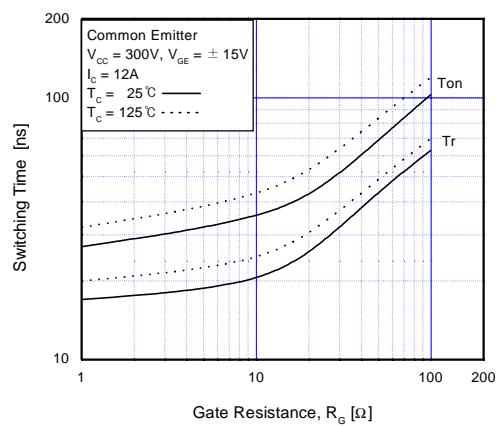
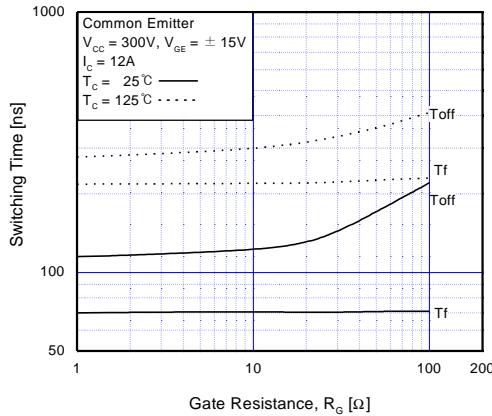
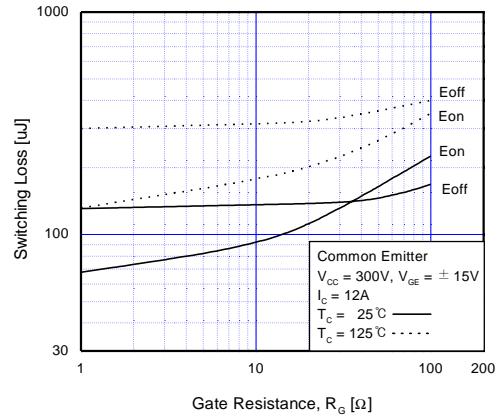
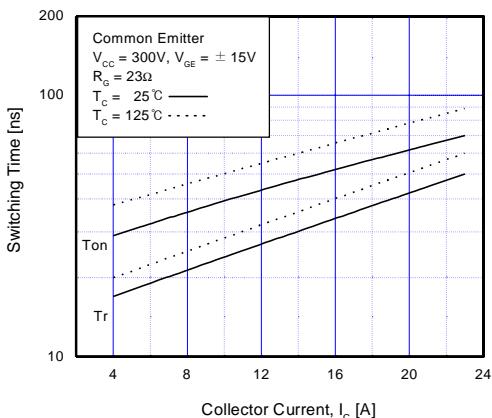
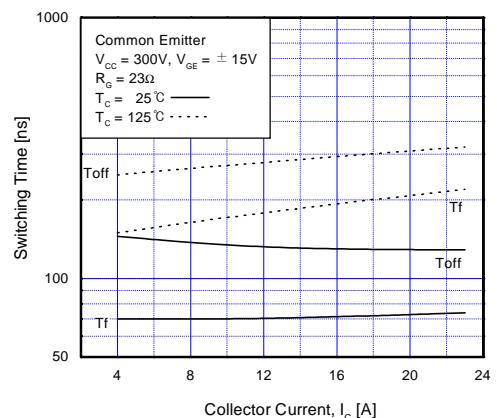
Electrical Characteristics of IGBT $T_C = 25^\circ\text{C}$ unless otherwise noted

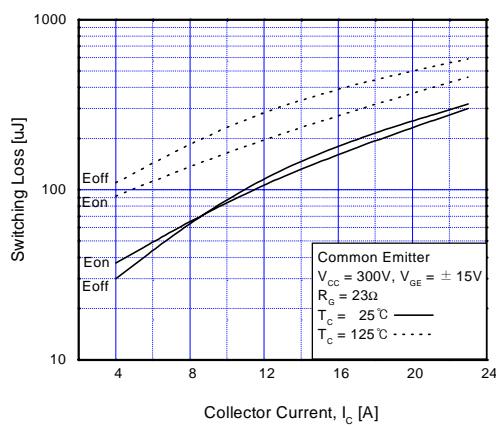
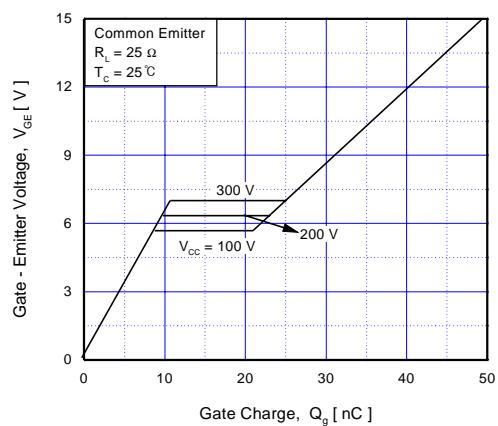
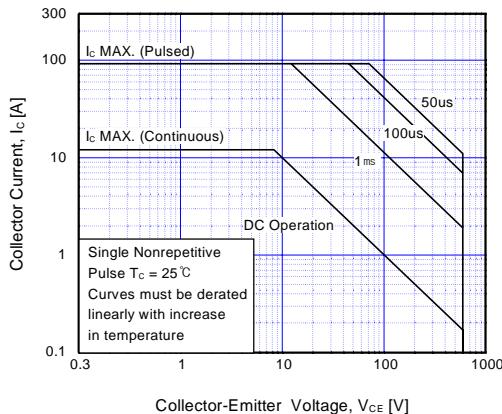
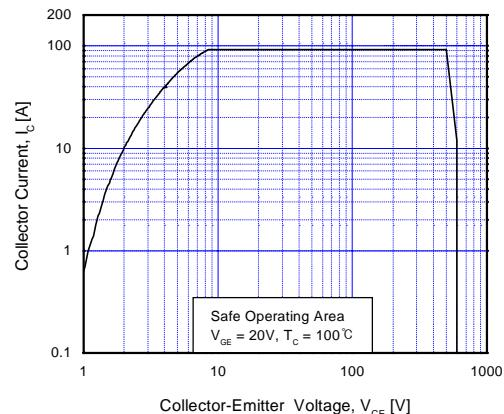
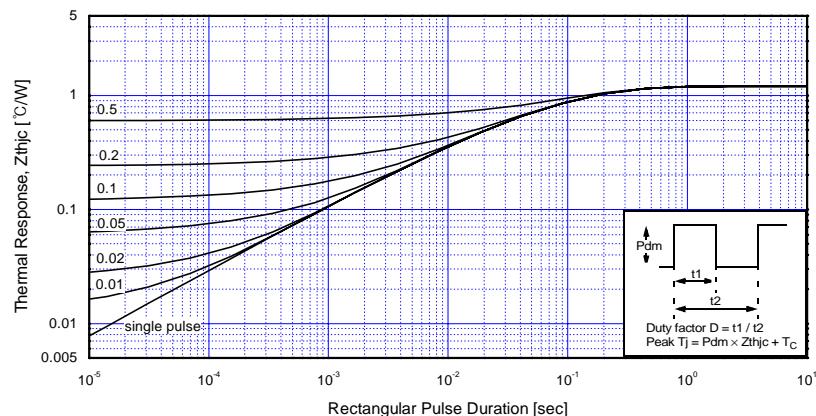
Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Units
Off Characteristics						
BV_{CES}	Collector-Emitter Breakdown Voltage	$V_{GE} = 0\text{V}, I_C = 250\mu\text{A}$	600	--	--	V
$\Delta B_{VCES}/\Delta T_J$	Temperature Coeff. of Breakdown Voltage	$V_{GE} = 0\text{V}, I_C = 1\text{mA}$	--	0.6	--	$\text{V}/^\circ\text{C}$
I_{CES}	Collector Cut-Off Current	$V_{CE} = V_{CES}, V_{GE} = 0\text{V}$	--	--	250	μA
I_{GES}	G-E Leakage Current	$V_{GE} = V_{GES}, V_{CE} = 0\text{V}$	--	--	± 100	nA
On Characteristics						
$V_{GE(\text{th})}$	G-E Threshold Voltage	$I_C = 12\text{mA}, V_{CE} = V_{GE}$	3.5	4.5	6.5	V
$V_{CE(\text{sat})}$	Collector to Emitter Saturation Voltage	$I_C = 12\text{A}, V_{GE} = 15\text{V}$	--	2.1	2.6	V
		$I_C = 23\text{A}, V_{GE} = 15\text{V}$	--	2.6	--	V
Dynamic Characteristics						
C_{ies}	Input Capacitance	$V_{CE} = 30\text{V}, V_{GE} = 0\text{V}, f = 1\text{MHz}$	--	720	--	pF
C_{oes}	Output Capacitance		--	100	--	pF
C_{res}	Reverse Transfer Capacitance		--	25	--	pF
Switching Characteristics						
$t_{d(on)}$	Turn-On Delay Time	$V_{CC} = 300\text{ V}, I_C = 12\text{A}, R_G = 23\Omega, V_{GE} = 15\text{V}, \text{Inductive Load}, T_C = 25^\circ\text{C}$	--	17	--	ns
t_r	Rise Time		--	27	--	ns
$t_{d(off)}$	Turn-Off Delay Time		--	60	130	ns
t_f	Fall Time		--	70	150	ns
E_{on}	Turn-On Switching Loss		--	115	--	uJ
E_{off}	Turn-Off Switching Loss		--	135	--	uJ
E_{ts}	Total Switching Loss		--	250	400	uJ
$t_{d(on)}$	Turn-On Delay Time		--	23	--	ns
t_r	Rise Time		--	32	--	ns
$t_{d(off)}$	Turn-Off Delay Time		--	100	200	ns
t_f	Fall Time	$V_{CC} = 300\text{ V}, I_C = 12\text{A}, R_G = 23\Omega, V_{GE} = 15\text{V}, \text{Inductive Load}, T_C = 125^\circ\text{C}$	--	220	250	ns
E_{on}	Turn-On Switching Loss		--	205	--	uJ
E_{off}	Turn-Off Switching Loss		--	320	--	uJ
E_{ts}	Total Switching Loss		--	525	800	uJ
Q_g	Total Gate Charge		--	49	80	nC
Q_{ge}	Gate-Emitter Charge	$V_{CE} = 300\text{ V}, I_C = 12\text{A}, V_{GE} = 15\text{V}$	--	11	17	nC
Q_{gc}	Gate-Collector Charge		--	14	22	nC
L_e	Internal Emitter Inductance	Measured 5mm from PKG	--	14	--	nH

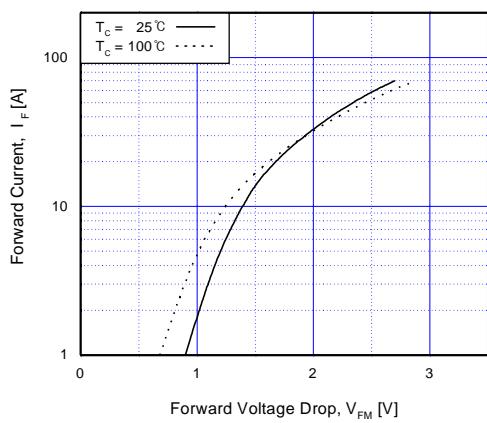
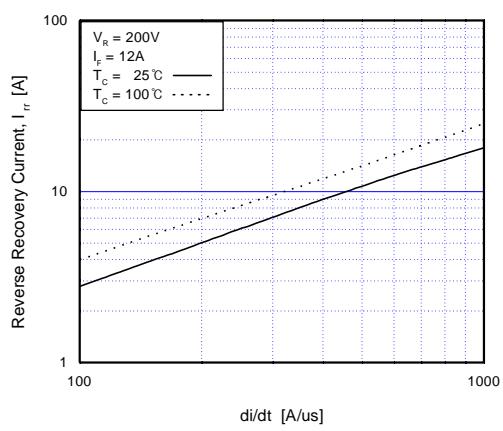
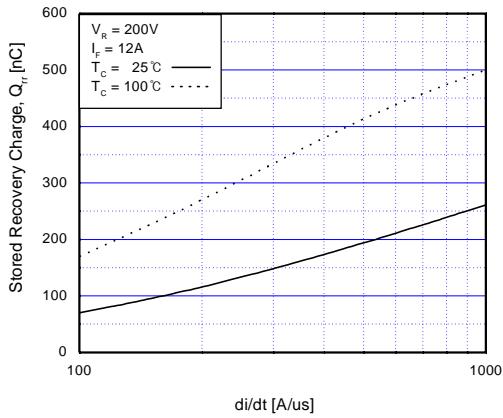
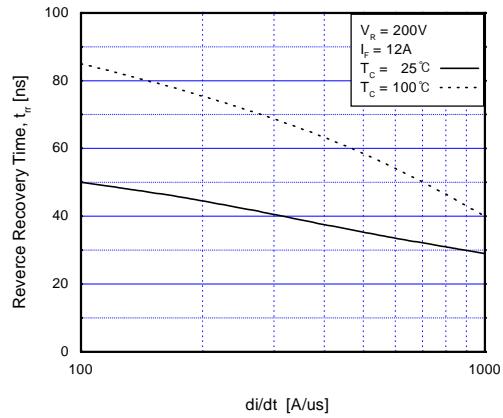
Electrical Characteristics of DIODE $T_C = 25^\circ\text{C}$ unless otherwise noted

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Units
V_{FM}	Diode Forward Voltage	$I_F = 12\text{A}$	$T_C = 25^\circ\text{C}$	--	1.4	1.7
			$T_C = 100^\circ\text{C}$	--	1.3	--
t_{rr}	Diode Reverse Recovery Time	$I_F = 12\text{A}, di/dt = 200\text{A/us}$	$T_C = 25^\circ\text{C}$	--	42	60
			$T_C = 100^\circ\text{C}$	--	80	--
I_{rr}	Diode Peak Reverse Recovery Current	$I_F = 12\text{A}, di/dt = 200\text{A/us}$	$T_C = 25^\circ\text{C}$	--	3.5	6.0
			$T_C = 100^\circ\text{C}$	--	5.6	--
Q_{rr}	Diode Reverse Recovery Charge	$I_F = 12\text{A}, di/dt = 200\text{A/us}$	$T_C = 25^\circ\text{C}$	--	80	180
			$T_C = 100^\circ\text{C}$	--	220	--

**Fig 1. Typical Output Characteristics****Fig 2. Typical Saturation Voltage Characteristics****Fig 3. Saturation Voltage vs. Case Temperature at Variant Current Level****Fig 4. Load Current vs. Frequency****Fig 5. Saturation Voltage vs. V_{GE}** **Fig 6. Saturation Voltage vs. V_{GE}**

**Fig 7. Capacitance Characteristics****Fig 8. Turn-On Characteristics vs. Gate Resistance****Fig 9. Turn-Off Characteristics vs. Gate Resistance****Fig 10. Switching Loss vs. Gate Resistance****Fig 11. Turn-On Characteristics vs. Collector Current****Fig 12. Turn-Off Characteristics vs. Collector Current**

**Fig 13. Switching Loss vs. Collector Current****Fig 14. Gate Charge Characteristics****Fig 15. SOA Characteristics****Fig 16. Turn-Off SOA Characteristics****Fig 17. Transient Thermal Impedance of IGBT**

**Fig 18. Forward Characteristics****Fig 19. Reverse Recovery Current****Fig 20. Stored Charge****Fig 21. Reverse Recovery Time**

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